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Cathode Anode

PRIMARY CHARACTERISTICS							
I _{F(AV)}	15 A						
V _R	600 V						
V _F at I _F	1.3 V						
t _{rr} typ.	22 ns						
T _J max.	175 °C						
Package	TO-220AC 2L						
Circuit configuration	Single						

FEATURES

Hyperfast Rectifier, 15 A FRED Pt[®]

- · Hyperfast recovery time
- · Low forward voltage drop
- 175 °C operating junction temperature
- · Low leakage current
- Designed and gualified according to JEDEC[®]-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers designed with optimized performance of forward voltage drop, hyperfast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS, inverters or as freewheeling diodes.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Peak repetitive reverse voltage	V _{RRM}		600	V					
Average rectified forward current	I _{F(AV)}	T _C = 140 °C	15						
Non-repetitive peak surge current	I _{FSM}	T _J = 25 °C	120	А					
Peak repetitive forward current	I _{FM}		30						
Operating junction and storage temperatures	T _J , T _{Stg}		-65 to +175	°C					

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)									
PARAMETER	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Breakdown voltage, blocking voltage	V_{BR}, V_{R}	I _R = 100 μA	600	-	-				
Forward voltage	V _F	I _F = 15 A	-	1.8	2.2	2.2 V			
		I _F = 15 A, T _J = 150 °C	-	1.3	1.6				
	I _R	$V_{R} = V_{R}$ rated	-	0.2	50				
Reverse leakage current		$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	30	30 500 µA				
Junction capacitance	CT	V _R = 600 V	-	20	-	pF			
Series inductance	L _S	Measured lead to lead 5 mm from package body	-	8.0	-	nH			

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FREE



DYNAMIC RECOVERY CHARACTERISTICS (T _C = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS			
		$I_F = 1 \text{ A}, \text{ d}I_F/\text{d}t = 100$	A/μs, V _R = 30 V	-	22	30			
Boyoroo roooyory timo		$I_F = 15 \text{ A}, \text{ d}I_F/\text{d}t = 100$	0 A/µs, V _R = 30 V	-	28	35	20		
Reverse recovery time	t _{rr}	T _J = 25 °C		-	29	-	ns		
		T _J = 125 °C	I _F = 15 A dI _F /dt = 200 A/μs V _R = 390 V	-	75	-			
Peak recovery current	1	T _J = 25 °C		-	3.5	-	A		
Feak recovery current	I _{RRM}	T _J = 125 °C		-	7	-			
Boyaraa raaayary aharaa	0	T _J = 25 °C		-	57	-	nC		
Reverse recovery charge	Q _{rr}	T _J = 125 °C		-	300	-			
Reverse recovery time	t _{rr}		I _F = 15 A	-	51	-	ns		
Peak recovery current	I _{RRM}	T _J = 125 °C	$dI_F/dt = 800 \text{ A/}\mu\text{s}$	-	20	-	А		
Reverse recovery charge	Q _{rr}		V _R = 390 V	-	580	-	nC		

THERMAL MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Maximum junction and storage temperature range	T _J , T _{Stg}		-65	-	175	°C		
Thermal resistance, junction-to-case	R _{thJC}		-	1.0	1.3			
Thermal resistance, junction-to-ambient per leg	R _{thJA}	Typical socket mount	-	-	70	°C/W		
Thermal resistance, case-to-heatsink	R _{thCS}	Mounting surface, flat, smooth, and greased	-	0.5	-			
Weight			-	2.0	-	g		
Weight			-	0.07	-	oz.		
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)		
Marking device		Case style TO-220AC 2L	15ETH06					

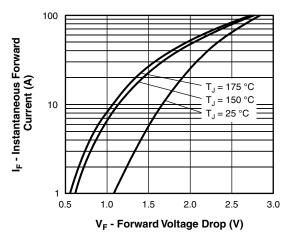


Fig. 1 - Typical Forward Voltage Drop Characteristics

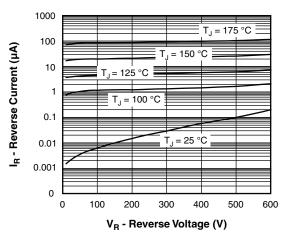


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

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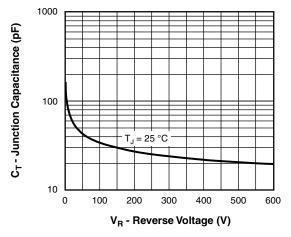


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

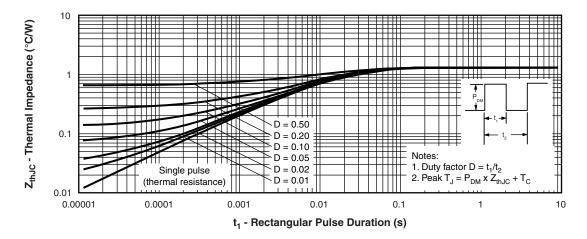
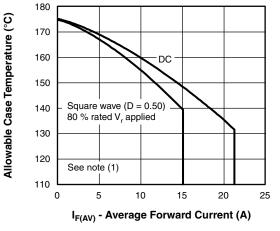
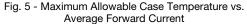


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics



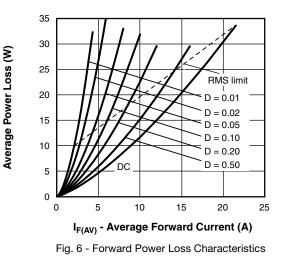
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⁽¹⁾ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;

 $\begin{array}{l} Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 5);} \\ Pd_{REV} = \text{inverse power loss} = V_{R1} \times I_{R} \left(1 - D\right); I_{R} \text{ at } V_{R1} = \text{rated } V_{R} \end{array}$



Revision: 11-Jan-2022

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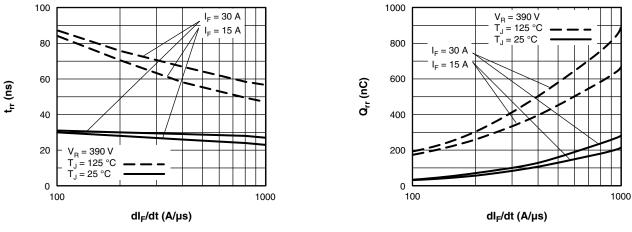


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

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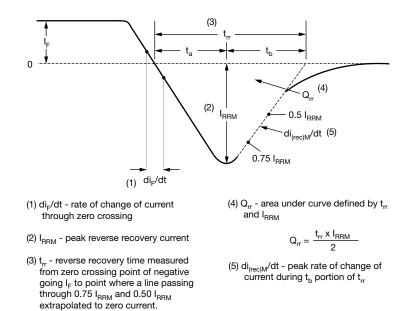


Fig. 9 - Reverse Recovery Waveform and Definitions

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ORDERING INFORMATION TABLE

Device code		45	-	-		00	
Device code	VS-	15	E	T	Н	06	-M3
	1	2	3	4	5	6	7
	1 - 2 - 3 -	Cur		niconduc ng (15 =		oduct	
	4 - 5 -	• T =	TO-220	, D ² PAk st recov		63AB)	
	6 - 7 -	· Volt · Env	age rati ironmer	ng (06 = ntal digit gen-free	= 600 V) ::	-compl	iant, an

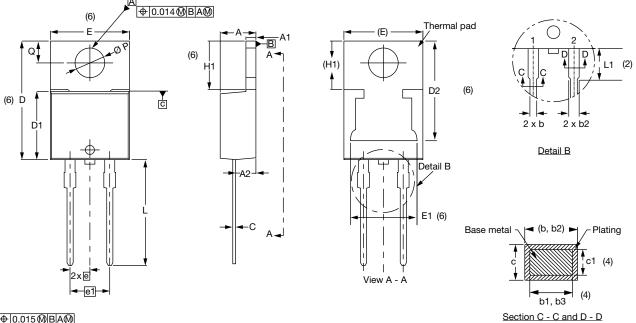
ORDERING INFORMATION (Example)							
PREFERRED P/N BASE QUANTITY PACKAGING DESCRIPTION							
VS-15ETH06-M3	50	Antistatic plastic tubes					

LINKS TO RELATED DOCUMENTS					
Dimensions www.vishay.com/doc?96156					
Part marking information	www.vishay.com/doc?95391				
SPICE model	www.vishay.com/doc?96617				



TO-220AC 2L

DIMENSIONS in millimeters and inches



⊕0.015@BA@



SYMBOL	MILLIN	IETERS	INCHES		NOTES
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.50	2.92	0.098	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
С	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.35	0.585	0.604	3
D1	8.38	9.02	0.330	0.355	

SYMBOL	MILLIN	IETERS	INCHES		NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	11.68	13.30	0.460	0.524	6, 7
Е	10.11	10.51	0.398	0.414	3, 6
E1	6.86	8.89	0.270	0.350	6
е	2.41	2.67	0.095	0.105	
e1	4.88	5.28	0.192	0.208	
H1	6.09	6.48	0.240	0.255	6
L	13.52	14.02	0.532	0.552	
L1	3.32	3.82	0.131	0.150	2
ØР	3.54	3.91	0.139	0.154	
Q	2.60	3.00	0.102	0.118	

Conforms to JEDEC[®] outline TO-220AC

Notes

⁽²⁾ Lead dimension and finish uncontrolled in L1

(4) Dimension b1, b3, and c1 apply to base metal only

- (6) Thermal pad contour optional within dimensions E, H1, D2, and E1
- ⁽⁷⁾ Outline conforms to JEDEC[®] TO-220, except D2

Revision: 07-Mar-2022

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Document Number: 96156

 $^{^{(1)}\,}$ Dimensioning and tolerancing as per ASME Y14.5M-1994 $\,$

⁽³⁾ Dimension D, D1, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁵⁾ Controlling dimensions: inches



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Revision: 01-Jan-2024